



Ying Chen

Institute of Flexible Electronics Technology of THU,
Jiaxing, Zhejiang, China.

Education

- Tsinghua University
Ph.D. degree in Solid Mechanics, July 2017.
- Southwest Jiaotong University
B.S. degree in Engineering Mechanics, July 2012.
B.S. degree in English, July 2012.

Publications

1. Du, Q., Liu, L., Tang, R., Ai, J., Wang, Z., Fu, Q., **Chen, Y.*** & Feng, X. High-Performance Flexible Pressure Sensor Based on Controllable Hierarchical Microstructures by Laser Scribing for Wearable Electronics. *Advanced Materials Technologies*, 2100122.
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